

01-10-2006

U.S. Department of Commerce
Patent and Trademark Office
Attorney Docket No. 04805.0231
Attorney Customer Number: 22,852

To the Director of the U.S. Patents and

103153976

and original documents or copy thereof.

1. **Name of conveying party(ies):**
In Kyu CHUN

2. **Name and address of receiving party(ies):**

Name: DONGBUANAM SEMICONDUCTOR INC.

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

Internal Address:

3. **Nature of conveyance/Execution Date(s):**

Execution Date(s) December 26, 2005

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other

Street Address: 891-10, Daechi-Dong, Kangnam-Ku,
Seoul, Korea

City:

State:

Zip Code:

Additional name(s) & Address(es) attached?

☐ Yes

☒ No

4. **Application number(s) or patent number(s):**

☒ This document is being filed together with a new application.

A. **Patent Application Number(s):**

B. **Patent Number(s):**

Additional numbers attached?

☐ Yes

☒ No

5. **Name and address of to whom correspondence concerning document should be mailed:**

Name: Mr. Ernest F. Chapman

6. **Total number of applications and registrations involved:**
1

7. **Total fee (37 CFR 3.41): \$40**

- ☐ Authorized to be charged by credit card
☐ Authorized to be charged to deposit account
☒ Enclosed (Please charge deficiency to deposit account)
☐ None required (government interest not affecting title)

Internal Address: FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER, L.L.P.

8. **Payment Information**

Street Address: 901 New York Avenue, NW

a. Credit Card Last 4 Numbers _____
Expiration Date _____

City: Washington, D.C.

b. Deposit Account No.: 06-0916

State: Zip: 20001-4413

Authorized User Name _____

8. **Statement and signature.**

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Ernest F. Chapman
Reg. No. 25,961

Signature

December 30, 2005
Date

Total number of pages including cover sheet, attachments and documents: 2

SOLE/JOINT INVENTION
(U.S. Rights Only)
Attorney Docket No. [Text]

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

TUNGSTEN PLUG STRUCTURE OF SEMICONDUCTOR DEVICE AND METHOD FOR FORMING THE SAME
for which I/WE executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on [Date], 20[Year] (Application No. [Text]); and

WHEREAS, DongbuAnam Semiconductor Inc.
a corporation of Republic of Korea

whose post office address is 891-10, Daechi-Dong, Kangnam-Ku, Seoul, Korea

(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/WE, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No.[Text], filed [Date]) the filing date and application number of said application when known:

IN TESTIMONY WHEREOF, I/We have hereunto set our hand(s).

1. FULL NAME OF SOLE OR FIRST ASSIGNOR In Kyu, CHUN	ASSIGNOR'S SIGNATURE: <i>CHUN</i>	DATE 12/26/2005
ADDRESS #202-1103 Hyunjin Apt., Sinhae-ri, Ganam-myeon, Yeoju-gun, Gyeonggi-do, Korea		CITIZENSHIP Republic of Korea
2. FULL NAME OF SECOND ASSIGNOR, IF ANY [Text]	ASSIGNOR'S SIGNATURE	DATE
ADDRESS [Text]		CITIZENSHIP [Text]
3. FULL NAME OF THIRD ASSIGNOR, IF ANY [Text]	ASSIGNOR'S SIGNATURE	DATE
ADDRESS [Text]		CITIZENSHIP [Text]